L Number	Hits	Search Text	DB	Time stamp
-	2	"20040051178"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 09:41
-	4	"6657305"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 09:45
-	1		USPAT	2004/10/05 09:41
-	1		USPAT	2004/10/05 09:42
-	1		USPAT	2004/10/05 09:42
-	1		USPAT	2004/10/05 09:43
-	1		USPAT	2004/10/05 09:43
-	1		USPAT	2004/10/05 09:43
-	1	@ad<=20001101 and 'interconnect' and 'recessed mask'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:41
-	451	@ad<=20001101 and 'interconnect' and 'low k' and 'mask'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 09:56
-	76	@ad<=20001101 and 'interconnect' same 'low k' same 'mask'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 10:28
-	11	@ad<=20001101 and 'recessed mask'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 10:27
-	71	@ad<=20001101 and 'interconnection' and 'mask layer' and 'cap layer'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:52
-	5	@ad<=20001101 and 'interconnection' and 'prevent' same 'high electrical fields'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 10:50
-	6	@ad<=20001101 and 'low k' and 'Si' adj1 'C' adj1 'H' and 'cap'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 10:55
-	8	@ad<=20001101 and 'Si' adj1 'C' adj1 'H' and 'cap'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 10:55
-	1	@ad<=20001101 and 'Si:C:H' and 'cap'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 10:55

-	26	@ad<=20001101 and 'Si' adj1 'C' adj1 'H' and 'mask'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:03
-	29	@ad<=20001101 and 'damascene' and 'low-k' and 'hardmask'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:04
-	355	@ad<=20001101 and (438/623).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:45
-	2507	@ad<=20001101 and (438/624).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 12:09
-	247	@ad<=20001101 and (438/625).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:46
-	324	@ad<=20001101 and (438/626).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:46
-	466	@ad<=20001101 and (438/627).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:47
-	153	@ad<=20001101 and (438/628).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:47
-	954	@ad<=20001101 and (438/643).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:48
-	180	@ad<=20001101 and (438/644).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:47
-	150	@ad<=20001101 and (438/645).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:48
-	1503	@ad<=20001101 and (438/690-692).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:49
-	1136	@ad<=20001101 and (438/637).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 12:09
-	402	@ad<=20001101 and (438/397).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:50
-	1		USPAT	2004/10/05 11:50

–	1		USPAT	2004/10/05 11:50
–	1		USPAT	2004/10/05 11:51
–	1		USPAT	2004/10/05 11:52
–	1		USPAT	2004/10/05 11:52
–	1		USPAT	2004/10/05 11:52
–	218	@ad<=20001101 and 'interconnection' same 'undercut'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:53
–	0	@ad<=20001101 and 'low k' and 'interconnection' same 'undercut'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 11:53
–	58	@ad<=20001101 and 'dielectric' and 'interconnection' same 'undercut'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 12:05
–	141	@ad<=20001101 and 'copper' same 'interconnection' and 'diffusion barrier' and 'low dielectric'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 12:07
–	58	@ad<=20001101 and 'copper' same 'interconnection' and 'diffusion barrier' and 'low dielectric' and 'mask'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 12:07
–	483	@ad<=20001101 and (438/633).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 12:09
–	360	@ad<=20001101 and (438/638).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 12:10